



6/19/2009

**PRODUCT RELIABILITY REPORT  
FOR**

**DS1629, Rev A5**

**Maxim Integrated Products**

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**Conclusion:**

The following qualification successfully meets the quality and reliability standards required of all Maxim products:

DS1629, Rev A5

In addition, Maxim's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at <http://www.maxim-ic.com/TechSupport/dsreliability.html>.

**Device Description:**

A description of this device can be found in the product data sheet. You can find the product data sheet at [http://dbserv.maxim-ic.com/l\\_datasheet3.cfm](http://dbserv.maxim-ic.com/l_datasheet3.cfm).

**Reliability Derating:**

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

$$AfT = \exp((Ea/k) * (1/Tu - 1/Ts)) = tu/ts$$

AfT = Acceleration factor due to Temperature  
tu = Time at use temperature (e.g. 55°C)  
ts = Time at stress temperature (e.g. 125°C)  
k = Boltzmann's Constant (8.617 x 10<sup>-5</sup> eV/°K)  
Tu = Temperature at Use (°K)  
Ts = Temperature at Stress (°K)  
Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

$$AfV = \exp(B * (Vs - Vu))$$

AfV = Acceleration factor due to Voltage  
Vs = Stress Voltage (e.g. 7.0 volts)  
Vu = Maximum Operating Voltage (e.g. 5.5 volts)  
B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

$$Fr = X / (ts * AfV * AfT * N * 2)$$

X = Chi-Sq statistical upper limit  
N = Life test sample size

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

$$MTTF = 1/Fr$$

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

**FAILURE RATE:**                      **MTTF (YRS):**      **100818**      **FITS:**              **1.1**  
**DEVICE HOURS:**      **809237384**      **FAILS:**              **0**

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

**Cf: 60%**              **Ea: 0.7**              **B: 0**              **Tu: 25 °C**              **Vu: 5.5 Volts**

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. **Bold** Product Number denotes specific product data.

**Device Information:**

Process:                      EC8W-1P2M,E2,MPVt2,ND-B,PD-D,RDSD,PF,ALOCOS:GOI 5" Reticles  
 Passivation:              Passivation w/Nov TEOS Oxide-Nitride  
 Die Size:                      76 x 139  
 Number of Transistors:      0  
 Interconnect:              Aluminum / 0.5% Copper  
 Gate Oxide Thickness:      175 Å

**ESD HBM**

DESCRIPTION	DATE	CODE/PRODUCT/LOT	CONDITION	READPOIN	QTY	FAILS	FA#
ESD SENSITIVITY	0913	<b>DS1629</b>	QJ929264BB JESD22-A114 HBM 500 VOLTS	1	PUL'S	3	0
ESD SENSITIVITY	0913	<b>DS1629</b>	QJ929264BB JESD22-A114 HBM 1000 VOLTS	1	PUL'S	3	0
ESD SENSITIVITY	0913	<b>DS1629</b>	QJ929264BB JESD22-A114 HBM 2000 VOLTS	1	PUL'S	3	1 No FA
ESD SENSITIVITY	0913	<b>DS1629</b>	QJ929264BB JESD22-A114 HBM 4000 VOLTS	1	PUL'S	3	2 No FA
ESD SENSITIVITY	0913	<b>DS1629</b>	QJ929264BB JESD22-A114 HBM 8000 VOLTS	1	PUL'S	3	3 No FA
<b>Total:</b>						<b>6</b>	

**LATCH-UP**

DESCRIPTION	DATE	CODE/PRODUCT/LOT	CONDITION	READPOIN	QTY	FAILS	FA#
LATCH-UP I	0913	<b>DS1629</b>	QJ929264BB JESD78A, I-TEST 125C			6	0
LATCH-UP V	0913	<b>DS1629</b>	QJ929264BB JESD78A, V-SUPPLY TEST 125C			6	0
<b>Total:</b>						<b>0</b>	

**OPERATING LIFE**

DESCRIPTION	DATE	CODE/PRODUCT/LOT	CONDITION	READPOIN	QTY	FAILS	FA#
HIGH TEMP OP LIFE	0646	DS75	QD702665AB 125C, 5.5 VOLTS	1000 HRS		77	0

HIGH TEMP OP LIFE	0719	DS1803	QE710643A 125C, 5.25 VOLTS	1000 HRS	77	0
HIGH TEMP OP LIFE	0719	DS1803	QE710643AH 125C, 5.25 VOLTS	1000 HRS	77	0
HIGH TEMP OP LIFE	0719	DS1803	QE710643AI- 125C, 5.25 VOLTS	1000 HRS	77	0
HIGH TEMP OP LIFE	0719	DS1803	QD710643AJ 125C, 5.25 VOLTS	1000 HRS	77	0
HIGH TEMP OP LIFE	0719	DS1803	QD710643AK 125C, 5.25 VOLTS	1000 HRS	77	0
HIGH TEMP OP LIFE	0719	DS1803	QD710643AL 125C, 5.25 VOLTS	1000 HRS	77	0
HIGH TEMP OP LIFE	0720	DS1844	ZK719430AC 125C, 5.5 VOLTS	1000 HRS	54	0
HIGH TEMP OP LIFE	0720	DS1844	ZK719430AD 125C, 5.5 VOLTS	1000 HRS	54	0
HIGH TEMP OP LIFE	0720	DS1844	ZK719430AE 125C, 5.5 VOLTS	1000 HRS	54	0
HIGH TEMP OP LIFE	0735	DS75	QJ740138AB 125C, 5.5 VOLTS	1000 HRS	77	0
HIGH TEMP OP LIFE	0750	DS1302	VJ801082AB 125C, 5.5 VOLTS	1000 HRS	80	0

**Total:** 0

**FAILURE RATE:**                    **MTTF (YRS):**            **100818**        **FITS:**            **1.1**  
**DEVICE HOURS:**            **809237384**        **FAILS:**            **0**